### TCXO HIGH STABILITY 105 °C HIGH TEMPERATURE

### TG7050CKN / SKN TG7050CMN / SMN

•Frequency range : 10 MHz to 54 MHz

•Supply voltage : 3.3 V Typ. •Frequency / temperature characteristics

:  $\pm 0.1 \times 10^{-6}$  Max. (-40 °C to +105 °C)

Free-run accuracy
 £4.6 × 10<sup>-6</sup> Max. / 20 years (for Stratum3)
 External dimensions
 7.0 × 5.0 × 1.5 mm (10 pins or 4 pins)
 Network synchronization, Stratum3, BTS, SyncE, IEEE1588, Microwave, BTS

•Features : 105 °C High temp, High stability





Product Number

TG7050CKN: X1G005661xxxx99 TG7050SKN: X1G005671xxxx99 TG7050CMN: X1G005681xxxx99 TG7050SMN: X1G005691xxxx99





TG7050CKN TG7050SKN (10 pins)

TG7050CMN TG7050SMN (4 pins)

# Specifications (characteristics)

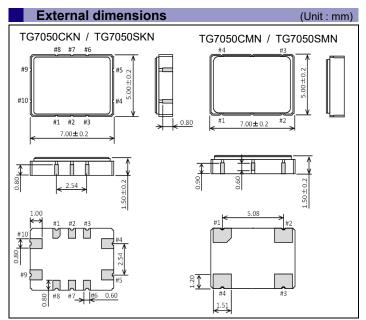
		21122		0 1111
Item	Symbol	CMOS	Clipped sine wave	Condition
Output frequency range	fo	10 MHz to 54 MHz		Please contact us about available frequencies.
Supply voltage	Vcc	3.3 V ± 5 %		
Storage temperature range	T_stg	-40 °C to +105 °C		Storage as single product.
Operating temperature range	T_use	-40 °C to +105 °C		
a) Frequency tolerance	f_tol	±1.0 × 10 <sup>-6</sup> Max.		After reflow, +25 °C
b) Frequency/temperature characteristics	fo-Tc	±0.1 × 10-6 Max.		-40 °C to +105 °C
c) Frequency/load coefficient	fo-Load	±0.1 × 10 <sup>-6</sup> Max.		Load ± 10 %
d) Frequency/voltage coefficient	$fo-V_{CC}$	±0.1 × 10 <sup>-6</sup> Max.		V <sub>CC</sub> ± 5 %
a) Fraguency aging	f ago	±0.5 × 10 <sup>-6</sup> Max.		+25 °C, First year
e) Frequency aging	f_age	±3.0 × 10 <sup>-6</sup> Max.		+25 °C, 20 years
Holdover stability	_	±0.01 × 10 <sup>-6</sup> Max. (+25 °C, 24 hours)		After 10 days of continuous operation
(Constant temperature)	_		(+25 °C, 24 hours)	After 48 hours of continuous operation
Wander generation (MTIE, TDEV)		Compliant with GR-1244CORE, ITU-T G.8262		2
Free-run accuracy	ı		lax. / 20 years	This includes Item a), b), c), d) and e)
	Icc	7.0 mA Max.	6.0 mA Max.	10 MHz ≤ fo ≤ 26 MHz
Current consumption		9.0 mA Max.		26 MHz < fo ≤ 40 MHz
		10.0 mA Max.		40 MHz < fo ≤ 54 MHz
Symmetry	SYM	45 % to 55 %	-	GND level (DC cut)
Output voltage	$V_{OH}$	90 % V <sub>CC</sub> Min.	-	
	$V_{OL}$	10 % V <sub>CC</sub> Max.	-	
Rise time / Fall time	tr/tf	8.0 ns Max.	-	10 % V <sub>CC</sub> to 90 % V <sub>CC</sub> level, Load: 15 pF
Start-up time	t_str	5 ms. Max.		t = 0 at 90 % V <sub>CC</sub>
Output level	Vpp	-	0.8 V Min.	Peak to Peak
Output load condition	Load	15 pF	10 kΩ // 10 pF	
Input voltage	$V_{IH}$	70% V <sub>CC</sub> Min.		OE terminal (Enable voltage)
	$V_{IL}$	30% V <sub>CC</sub> Max.		OE terminal (Disable voltage)

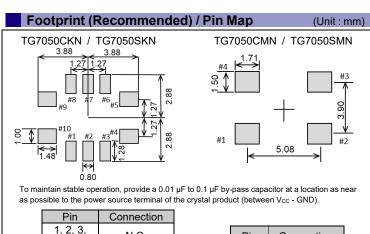
\* Note : Please contact us for requirements not listed in this specification.

①Model ②Output (C: CMOS, S: Clipped sine wave) ③Package type (K: 10 pins, M: 4 pins) ④Frequency ⑤Supply voltage (C: 3.3 V Typ.)

⑥Frequency / temperature characteristics (A: ±0.1 × 10<sup>-6</sup> Max.) ⑦Operating temperature (H: -40 °C to +105 °C)

®OE function (H: Active High, N: Non) 
®Vc function (G: Vc Non) 
®Internal identification code ("A" is default)





Pin	Connection	
1, 2, 3, 6, 7, 10	N.C.	
4	GND	
5	OUT	
8	OE	
9	$V_{cc}$	

OE pin = "H" or "open": Specified frequency output. OE pin = "L" : Output is high impedance.

	Pin	Connection
	1	N.C
	2	GND
	3	OUT
Г	4	$V_{cc}$

# PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

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In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major automotive manufacturers as standard.

IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

Explanation of the mark that are using it for the catalog



►Pb free.



► Complies with EU RoHS directive.

\*About the products without the Pb-free mark.

Contains Pb in products exempted by EU RoHS directive.

(Contains Pb in sealing glass, high melting temperature type solder or other.)



▶ Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.



▶ Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc.).

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